2SCR523M / 2SCR523EB / 2SCR523UB

NPN 100mA 50V General Purpose Transistor

Datasheet

Parameter	Value
V _{CEO}	50V
I _C	100mA

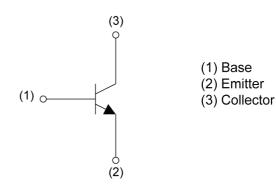
Outline

SOT-723	SOT-416FL
(1) (2)	(1) (3)
2SCR523M	2SCR523EB
(VMT3)	(EMT3F)
SOT-323FL	
(1) (2)	
2SCR523UB	
(UMT3F)	

Features

- 1) General Purpose.
- 2) Complementary PNP Types: 2SAR523M (VMT3) / 2SAR523EB (EMT3F) / 2SAR523UB (UMT3F)

•Inner circuit



Application

GENERAL PURPOSE SMALL SIGNAL AMPLIFIER

Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
2SCR523M	SOT-723 (VMT3)	1212	T2L	180	8	8000	NB
2SCR523EB	SOT-416FL (EMT3F)	1616	TL	180	8	3000	NB
2SCR523UB	SOT-323FL (UMT3F)	2021	TL	180	8	3000	NB

● Absolute maximum ratings (T_a = 25°C)

Parameter			Values	Unit
Collector-base voltage			50	V
Collector-emitter voltage			50	V
Emitter-base voltage			5	V
Calla stan average	I _C	100	mA	
Collector current		I _{CP} *1	200	mA
	2SCR523M		150	
Power dissipation	2SCR523EB	P _D *2	150	mW
		200		
Junction temperature	T _j	150	°C	
Range of storage tempera	T _{stg}	-55 to +150	°C	

● Electrical characteristics (T_a = 25°C)

Donomoston	Curah al	Conditions		Values		Unit	
Parameter	Symbol Conditions		Min.	Тур.	Max.	UI III	
Collector-base breakdown voltage	BV _{CBO}	I _C = 50μA	50	-	-	V	
Collector-emitter breakdown voltage	BV _{CEO}	I _C = 1mA	50	-	-	V	
Emitter-base breakdown voltage	BV _{EBO}	I _E = 50μA	5	1	1	V	
Collector cut-off current	I _{CBO}	V _{CB} = 50V	-	-	100	nA	
Emitter cut-off current	I _{EBO}	V _{EB} = 5V	-	-	100	nA	
Collector-emitter saturation voltage	V _{CE(sat)}	$I_C = 50 \text{mA}, I_B = 5 \text{mA}$	-	100	300	mV	
DC current gain	h _{FE}	$V_{CE} = 6V, I_C = 1mA$	120	-	560	-	
Transition frequency	f _T	V _{CE} = 10V, I _E = -10mA, f = 100MHz	-	350	-	MHz	
Output capacitance	C _{ob}	V _{CB} = 10V, I _E = 0A, f = 1MHz	-	1.6	-	pF	

^{*1} Pw=10ms Single Pulse

^{*2} Each terminal mounted on a reference land.

● Electrical characteristic curves(T_a = 25°C)

Fig.1 Ground Emitter Propagation

Characteristics

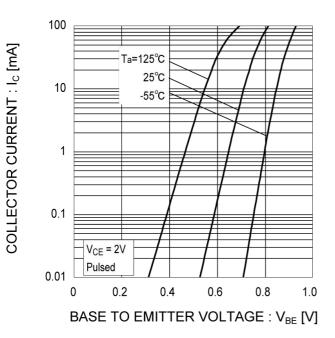
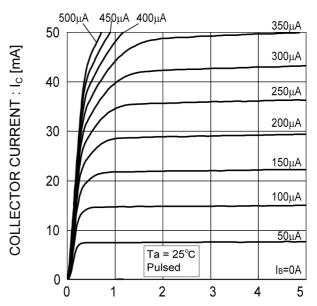


Fig.2 Typical Output Characteristics



COLLECTOR TO EMITTER VOLTAGE: V_{CE} [V]

Fig.3 DC Current Gain vs. Collector Current (I)

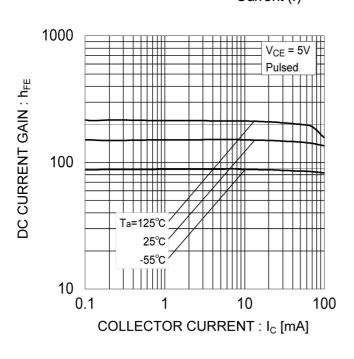
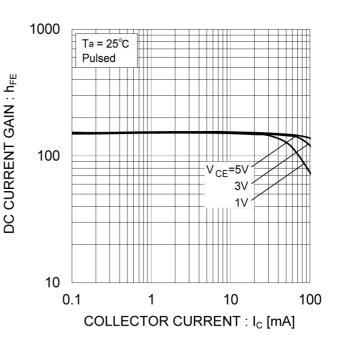


Fig.4 DC Current Gain vs. Collector
Current (II)



● Electrical characteristic curves(T_a = 25°C)

Fig.5 Collector-Emitter Saturation Voltage vs. Collector Current (I)

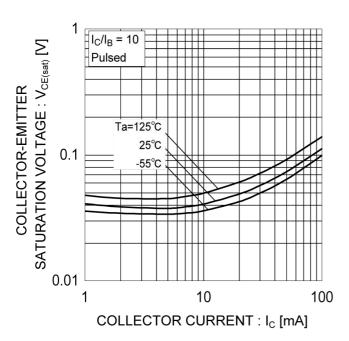


Fig.6 Collector-Emitter Saturation

Voltage vs. Collector Current (II)

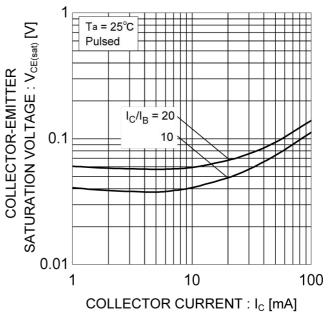


Fig.7 Base-Emitter Saturation Voltage vs. Collector Current

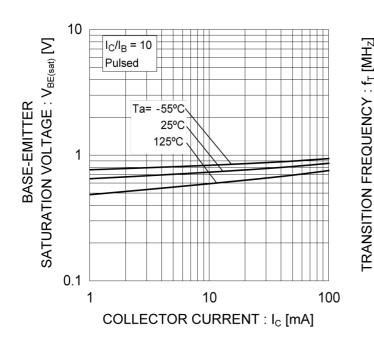
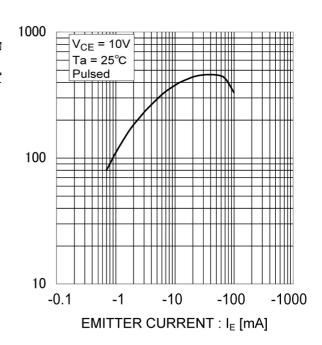


Fig.8 Gain Bandwidth Product vs.

Emitter Current



● Electrical characteristic curves(T_a = 25°C)

Fig.9 Emitter Input Capacitance vs.
Emitter-Base Voltage
Collector Output Capacitance vs.
Collector-Base Voltage

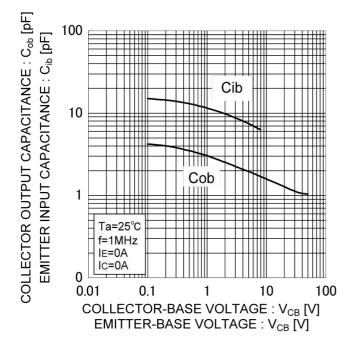


Fig.10 Safe Operating Area

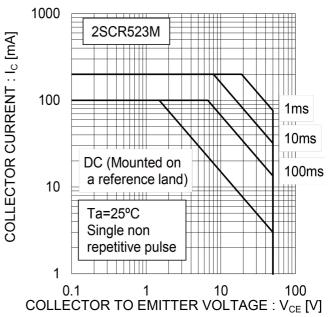


Fig.11 Safe Operating Area

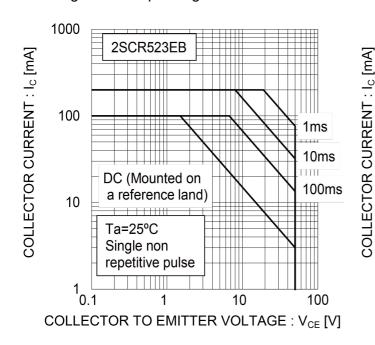
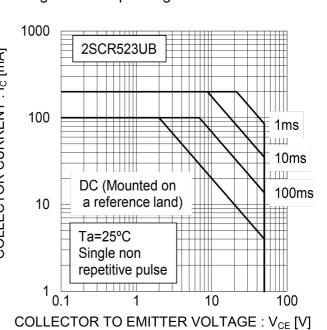
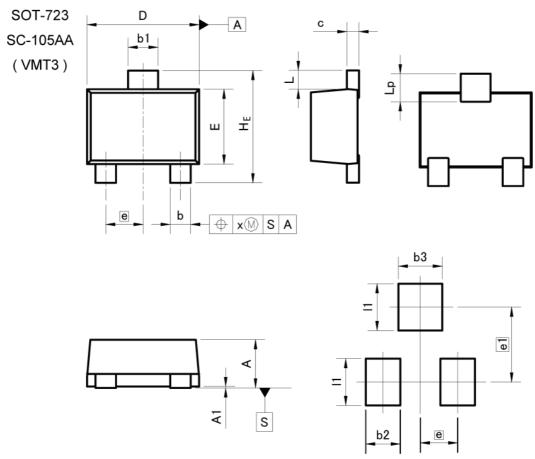


Fig.12 Safe Operating Area



Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

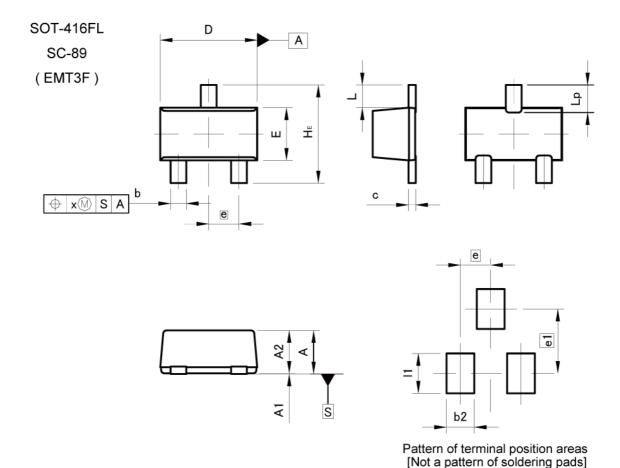
DIM -	MILIM	ETERS	INC	HES
DIM [MIN	MAX	MIN	MAX
Α	0.45	0.55	0.018	0.022
A1	0.00	0.10	0.000	0.004
b	0.17	0.27	0.007	0.011
b1	0.27	0.37	0.011	0.015
С	0.08	0.18	0.003	0.007
D	1.10	1.30	0.043	0.051
E	0.70	0.90	0.028	0.035
е	0.4	40	0.02	
HE	1.10	1.30	0.043	0.051
L	0.10	0.30	0.004	0.012
Lp	0.20	0.40	0.008	0.016
х	#	0.10	<u> </u>	0.004

DIM	MILIM	ETERS	INCHES	
DIM	MIN	MAX	MIN	MAX
b2	<u> </u>	0.37	544	0.015
b3	223	0.47	9 <u>100</u>	0.019
e1	0.80		0.0	031
11	-	0.50	277	0.020

Dimension in mm/inches



Dimensions



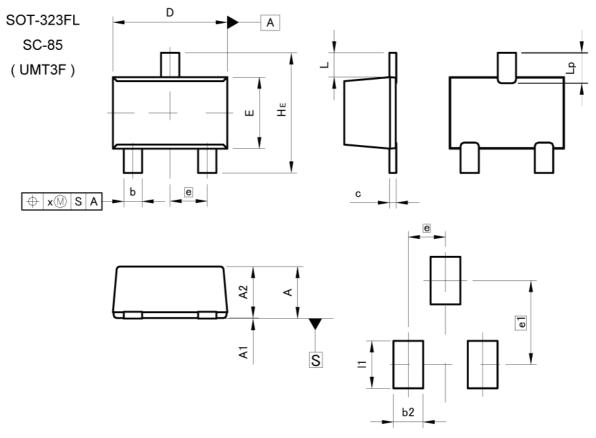
MILIMETERS INCHES DIM MIN MAX MIN MAX 0.85 0.033 A 0.65 0.026 A1 0.00 0.10 0.000 0.004 A2 0.60 0.80 0.024 0.031 b 0.21 0.36 0.008 0.014 0.003 0.007 0.08 0.18 C D 1.50 1.70 0.059 0.067 0.76 0.96 0.030 E 0.038 0.50 0.020 е HE 1.50 1.70 0.059 0.067 0.37 0.015 L 0.35 0.55 0.014 0.022 Lp 0.10 0.004 X

DIM -	MILIMETERS		INCHES	
DIM [MIN	MAX	MIN	MAX
b2	= 1	0.46	_	0.018
e1		1.05	_	0.041
11	#	0.65	=	0.026

Dimension in mm/inches



Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

DIM -	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	0.85	1.05	0.033	0.041
A1	0.00	0.10	0.000	0.004
A2	0.80	1.00	0.031	0.039
b	0.27	0.42	0.011	0.017
С	0.08	0.18	0.003	0.007
D	1.90	2.10	0.075	0.083
E	1.15	1.35	0.045	0.053
е	0.0	65	0.026	
HE	2.00	2.20	0.079	0.087
L	0.43		0.0	
Lp	0.43	0.63	0.017	0.025
х	-	0.10		0.004

DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
b2	=1	0.52	-	0.020
e1	1.47		0.0	058
- 11	=	0.83	100 P	0.033

Dimension in mm/inches



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JAPAN	USA	EU	CHINA
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 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
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- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
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- 8. Confirm that operation temperature is within the specified range described in the product specification.
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 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
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- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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